



Halnziye HY910 - 75gram Thermal Conductive Silicone Plaster Viscous Adhesive Compound Cooling Glue For LED GPU Chipset Heatsink

Description

- * 100% New Heatsink plaster.
- * Application: apply to all heatsink no fixed clip thermal paste. Idea for MOSFET Heatsink,VGA CARD Northbridge Southbridge Heatsink.
- * Special properties: High Conductivity; low bleed; stable at high temperatures.
- * Features: thermal properties, strong adhesion
- * Thermal Resistance: $<0.246 \text{ in}^2 / \text{W}$
- * Type: silicone fluid.
- * Physical Form: Grease-like
- * Evaporation: 0.001% (200 ? / 24Hours)
- * Thermal conductivity: $> 0.671 \text{ W/m-K}$
- * Dielectric Breakdown: $>6.0 \text{ KV ac}$
- * Maximum Use Temperature: $-20? \sim 250?.$
- * Strength of connected buildings: 25Kg
- * Insulation coefficient > 5.1
- * Dissipation coefficient <0.005
- * 50ml /PCS , approx 75g

Package Includes:

1 x 75g Thermal Heatsink Plaster Glue.